S1AB - S1MB

Taiwan Semiconductor

1A, 50V - 1000V Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Part no. with suffix "H" means AEC-Q101 qualified
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.09 g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I _{F(AV)}	1	А			
V _{RRM}	50 - 1000	V			
I _{FSM}	30	А			
T _{J MAX}	150	°C			
Package	DO-214AA (SMB)				
Configuration	Single Die				



DO-214AA (SMB)

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)									
PARAMETER	SYMBOL	S1AB	S1BB	S1DB	S1GB	S1JB	S1KB	S1MB	UNIT
Marking code on the device		S1AB	S1BB	S1DB	S1GB	S1JB	S1KB	S1MB	
Repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Forward current	I _{F(AV)}				1				Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	30			A				
Junction temperature	ΤJ	- 55 to +150			°C				
Storage temperature	T _{STG}	- 55 to +150			°C				

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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-lead thermal resistance	R _{eJL}	30	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT	
Forward voltage per diode (1)	I _F = 1A,T _J = 25°C	V _F	-	1.1	V	
	T _J = 25°C		-	5	μA	
Reverse current @ rated V_R per diode ⁽²⁾	T _J = 125°C	I _R	-	50	μA	
Junction capacitance	1 MHz, V _R =4.0V	CJ	12	-	pF	

Notes:

1. Pulse test with PW=0.3 ms

2. Pulse test with PW=30 ms

DRDERING INFORMATION							
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX(*)	PACKAGE	PACKING		
		R5		SMB	850 / 7" Plastic reel		
S1xB (Note 1)	Н	R4	G	SMB	3,000 / 13" Paper reel		
		M4		SMB	3,000 / 13" Plastic reel		

Note:

1. "x" defines voltage from 50V (S1AB) to 1000V (S1MB)

: Optional available

EXAMPLE P/N					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING Code	PACKING CODE SUFFIX	DESCRIPTION
S1ABHR5G	S1AB	Н	R5	G	AEC-Q101 qualified Green compound



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

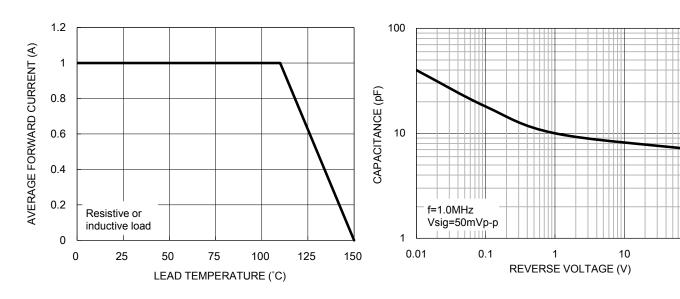
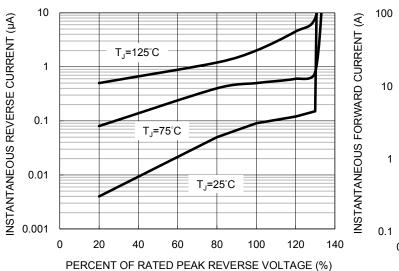


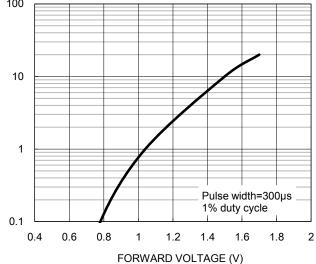
Fig1. Forward Current Derating Curve

Fig2. Typical Junction Capacitance

Fig3. Typical Reverse Characteristics

Fig4. Typical Forward Characteristics





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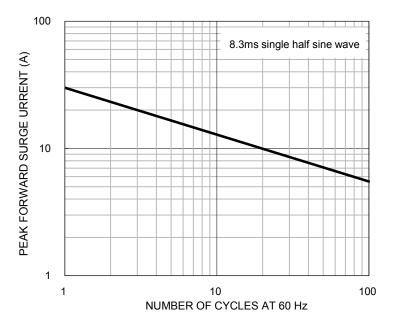
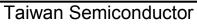


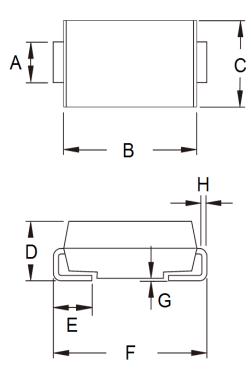
Fig5. Maximum Non-repetitive Forward Surge Current





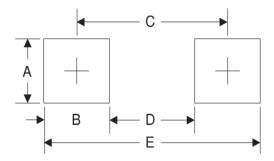
PACKAGE OUTLINE DIMENSIONS

DO-214AA (SMB)



DIM.	Unit (mm)		Unit	(inch)
Dilvi.	Min	Min Max		Max
А	1.95	2.20	0.077	0.087
В	4.05	4.60	0.159	0.181
С	3.30	3.95	0.130	0.156
D	1.95	2.65	0.077	0.104
Е	0.75	1.60	0.030	0.063
F	5.10	5.60	0.201	0.220
G	0.05	0.20	0.002	0.008
Н	0.15	0.31	0.006	0.012

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.3	0.091
В	2.5	0.098
С	4.3	0.169
D	1.8	0.071
E	6.8	0.268

MARKING DIAGRAM



P/N

Marking CodeGreen Compound G

YW = Date Code

F = Factory Code



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